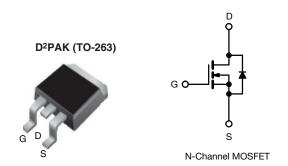
Vishay Siliconix

HALOGEN FREE

## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.85				
Q <sub>g</sub> max. (nC)	63				
Q <sub>gs</sub> (nC)	9.3				
Q <sub>gd</sub> (nC)	32				
Configuration	Single				



#### **FEATURES**

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirement
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### Note

This datasheet provides information about parts that are ROHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION						
Package D²PAK (TO-263) D²PAK (TO-263) D²PAK (TO-263)						
Lead (Pb)-free and Halogen-free	SiHF840S-GE3	SiHF840STRL-GE3 <sup>a</sup>	SiHF840STRR-GE3 a			
Lead (Pb)-free	IRF840SPbF	IRF840STRLPbF <sup>a</sup>	IRF840STRRPbF <sup>a</sup>			
	SiHF840S-E3	SiHF840STL-E3 a	SiHF840STR-E3 a			

#### Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	500	V	
Gate-Source Voltage			$V_{GS}$	± 20	7 v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I-	8.0		
Continuous Diain Current	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	5.1	Α	
Pulsed Drain Current <sup>a</sup>			$I_{DM}$	32		
Linear Derating Factor				1.0	W/°C	
Linear Derating Factor (PCB mount) e				0.025	VV/ C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	510	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	8.0	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$				125	w	
Maximum Power Dissipation (PCB mount) e T <sub>A</sub> = 25 °C			$P_D$	3.1	T vv	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	- °C	
Soldering Recommendations (Peak temperature) d for 10 s				300	7	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- $V_{DD}=50$  V, starting  $T_J=25$  °C, L = 14 mH,  $R_g=25$   $\Omega,$   $I_{AS}=8.0$  A (see fig. 12).  $I_{SD}\leq 8.0$  A, dl/dt  $\leq 100$  A/µs,  $V_{DD}\leq V_{DS},$   $T_J\leq 150$  °C. 1.6 mm from case.

- When mounted on 1" square PCB (FR-4 or G-10 material).



# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Maximum Junction-to-Ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0			

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•		L	L		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$ , $I_D = 250 \mu A$		500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.78	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zana Oata Valtana Dusin Orumant		V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 4.8 A <sup>b</sup>	-	-	0.85	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 4.8 A <sup>b</sup>	4.9	-	-	S
Dynamic						•	
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	1300	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 \text{ V},$	=	310	-	рF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	f = 1.0 MHz, see fig. 5		120	-	
Total Gate Charge	Qg			-	-	63	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V		-	9.3	nC
Gate-Drain Charge	Q <sub>gd</sub>		See fig. 6 and 16	-	-	32	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 250 \text{ V}, I_D = 8.0 \text{ A},$ $R_g = 9.1 \Omega, R_D = 31 \Omega, \text{ see fig. } 10^b$		-	14	-	- ns
Rise Time	t <sub>r</sub>			-	23	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	49	-	
Fall Time	t <sub>f</sub>			-	20	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>	package and die contact	center of	-	7.5	-	- nH
Gate Input Resistance	Rg	f = 1	MHz, open drain	0.6	-	2.8	Ω
Drain-Source Body Diode Characteristic	s					•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	8.0	^
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	32	- A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	$I_{S} = 8.0 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 °C '	0 0 0 41/4+ 400 0 / - b	-	460	970	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 8.0  \text{A}, dI/dt = 100  \text{A/} \mu \text{s}^{ \text{b}}$		-	4.2	8.9	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					L <sub>D</sub> )

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

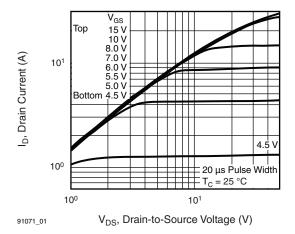


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

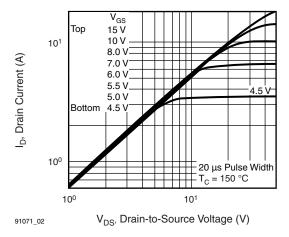


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

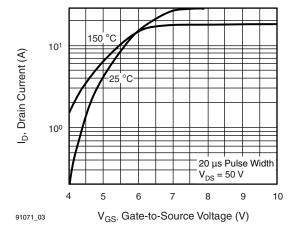


Fig. 3 - Typical Transfer Characteristics

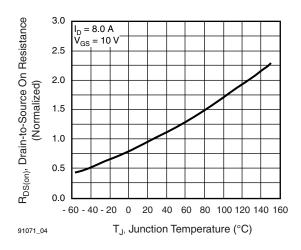


Fig. 4 - Normalized On-Resistance vs. Temperature

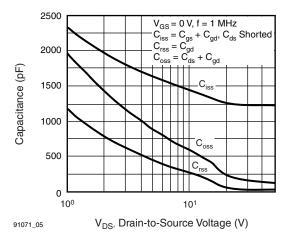


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

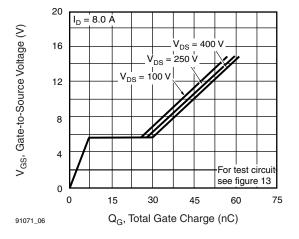


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



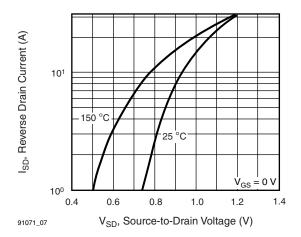


Fig. 7 - Typical Source-Drain Diode Forward Voltage

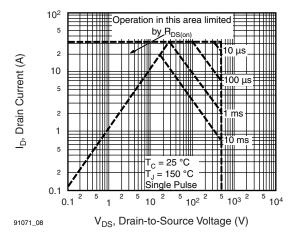


Fig. 8 - Maximum Safe Operating Area

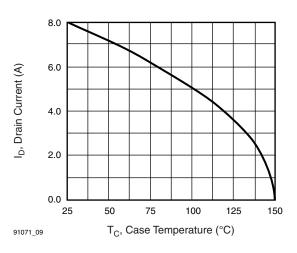


Fig. 9 - Maximum Drain Current vs. Case Temperature

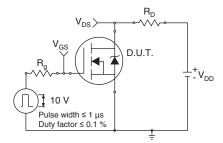


Fig. 10a - Switching Time Test Circuit

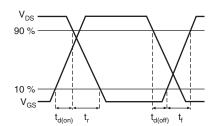


Fig. 10b - Switching Time Waveforms

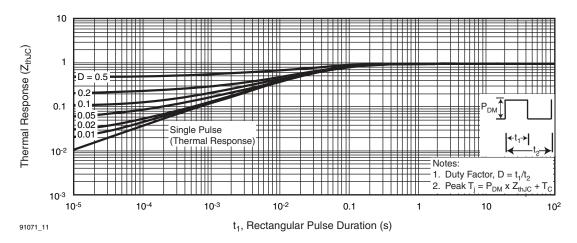
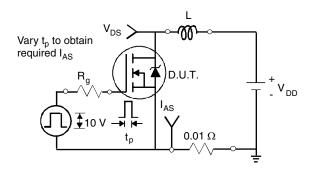


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





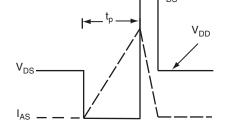


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

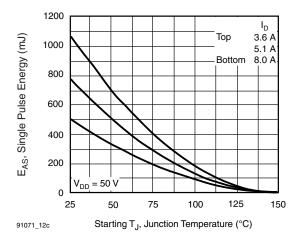


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

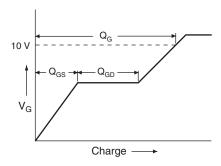


Fig. 13a - Basic Gate Charge Waveform

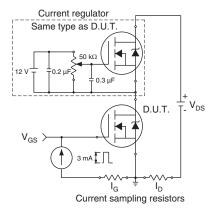
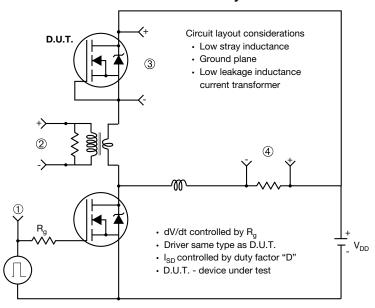


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



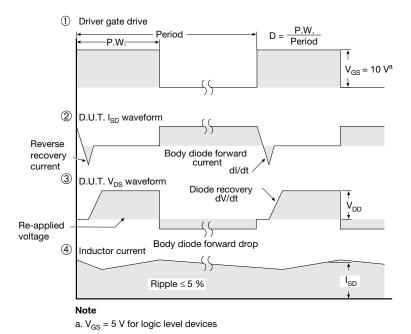


Fig. 14 - For N-Channel

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## **TO-263AB (HIGH VOLTAGE)**







]	+		D1	4
	-E1-	<b>₩</b>	<u> </u>	7

	MILLIN	METERS	INC	HES
DIM.	MIN. MAX.		MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIN	METERS	INC	HES	
DIM.	MIN.	MIN. MAX.		MAX.	
D1	6.86	-	0.270	-	
E	9.65	10.67	0.380	0.420	
E1	6.22	-	0.245	i	
е	2.54	BSC	0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	ı	0.066	
L2	-	1.78	i	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

### DWG: 5970 Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).

ECN: S-82110-Rev. A, 15-Sep-08

- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

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